

Multifunctional and Hybrid Microsystems Room Ballroom A - Session MC-ThP

Multifunctional and Hybrid Microsystems Poster Session

MC-ThP-1 Integrated Magnetic Bio-MEMS for High-Speed, Trajectory-Based Microparticle Classification in Laminar Microfluidic Channels, *Muhammad Tahir, Umer Hassan*, Rutgers, The State University of New Jersey

Microfluidic diagnostics increasingly depend on microsystems that combine sample handling, physical actuation, optical readout, and data analysis within one workflow. We present a magnetically actuated bio-MEMS platform that uses particle motion, rather than fluorescence or impedance, as the primary signal for distinguishing magnetically responsive microparticles in flow. The approach integrates a laminar polymer microchannel, an external permanent magnet, high-speed brightfield imaging, and automated video analysis, making it relevant to multifunctional microsystems where sensing, actuation, and signal processing are co-designed.

The device was constructed from three laser-cut polymer layers to form a transparent channel with a 35 mm length, 150 μm width, and 87 μm height. Nonmagnetic polystyrene beads and magnetic beads, both approximately 5–5.9 μm in diameter, were used as model negative and positive particle populations. Samples were introduced at 5 $\mu\text{L}/\text{min}$, producing an estimated particle velocity of 6.4 mm/s. Motion was recorded at 3,030 frames/s with 324 μs exposure over a field of view of approximately 600 $\mu\text{m} \times 162 \mu\text{m}$. A computer-vision pipeline converted the image sequence into particle centroids, reconstructed paths, and extracted trajectory slope as a compact metric of magnetically induced lateral displacement. COMSOL Multiphysics modeling guided the microsystem geometry before testing. Simulations examined magnet-channel spacing from 0–10 mm, magnet width from 3.175–9 mm, and channel widths from 250–750 μm . The model showed that smaller magnet-channel separation, larger magnet width, and narrower channels improved deflection within the imaging window; for example, mean simulated slope decreased from 0.151 to 0.005 when the magnet was moved from the channel edge to 10 mm away.

Later, experimental data confirmed that trajectory-derived signatures can separate the two particle groups. Using a slope threshold of 0.03, 240 of 393 magnetic particles were classified as deflected, compared with 53 of 347 control particles. This corresponded to 61% deflection for the magnetic population and 15.2% apparent deflection for controls. Mean trajectory slope shifted from -0.01 ± 0.059 for control beads to 0.039 ± 0.062 for magnetic beads, demonstrating measurable motion contrast between populations. This work demonstrates an integrated fluidic-actuation-imaging-analysis platform for magnetic microparticle classification. With improved tracking and antibody-labeled cell validation, the system could support compact bio-MEMS workflows for cell phenotyping, surface-marker-linked magnetic response, and low-cost diagnostic microsystems.

MC-ThP-2 Internal Friction, Creep, and Mechanical Behavior of Zr-Based Metallic Glass Thin Films for MEMS/NEMS Applications, *Kai-An Yang, Yan-Wei Chang*, National Chung Hsing University, Taiwan; *Hsiang-Yu Hsieh, Chen-Jia Wang*, National Chung Hsing University, Taiwan; *Tra Anh Khoa Nguyen, Ming-Tzer Lin*, National Chung Hsing University, Taiwan

Zr-based metallic glass alloys exhibit high hardness, wear and corrosion resistance, ductility, high strain toughness, and low Young's modulus, making them attractive candidates for MEMS and NEMS devices. Yet, research on the internal friction characteristics, creep behavior, and fracture mechanisms of metallic glass thin films remains limited, and the fundamental processes of internal friction and shear band slip within their amorphous structure are not fully understood. In this study, Zr-Cu-Ti metallic glass thin films are employed to investigate anelastic mechanical behavior, creep resistance, and fracture response across a broad temperature range from room temperature to elevated conditions. Internal friction measurements and bulge tests are conducted to quantify energy dissipation, structural relaxation, and crack propagation resistance. In addition, Zr-Cu-Ti metallic glass thin films are also examined before and after annealing to investigate the effects of phase transformation from amorphous to crystalline states. Preliminary results indicate that annealing-induced crystallization alters internal friction and mechanical performance, establishing correlations between atomic-scale structural evolution and macroscopic reliability. These findings provide new insights into the

reliability of metallic glass thin films, enabling their integration into MEMS/NEMS devices where durability, adaptability, and long-term stability are critical. This work directly supports the MEMS and NEMS area of interest by advancing knowledge of thin-film mechanical behavior under structural transformation.

MC-ThP-3 Influence of the Structural Regions of a Si_3N_4 Membrane Window on the CMOS Image Sensor Signal, *Kamil Baranowski, Michał Krysztof, Michał Zychla*, Wrocław University of Science and Technology, Poland; *Rupert Schreiner, Matthias Hausladen*, Ostbayerische Technische Hochschule (OTH) Regensburg, Germany; *Mathias Bartl*, Ostbayerische Technische Hochschule (OTH) Regensburg, Germany; *Alexandr Knápek*, Institute of Scientific Instruments of the Czech Academy of Sciences, Czechia

1. Introduction

A CMOS sensor coated with a copper layer can be used to detect an electron beam [1]. Incoming electrons are decelerated within the layer, generating Bremsstrahlung X-rays, which the sensor records and converts into a beam's image. The target application is the detection of an electron beam in a gaseous environment [2]. A silicon nitride (Si_3N_4) membrane separates the vacuum environment of the electron-optical column from the gaseous environment of the sensor, maintaining the pressure difference while allowing electron transmission. Here we examine how the membrane and supporting silicon chip influences the CMOS signal, aiming to isolate its contribution from effects caused by other factors, such as gas composition.

2. Experiment

To assess this, the CMOS signal intensity was mapped along a line scanning the membrane (Fig. 1). The CMOS matrix was mounted inside a JEOL JSM-100 SEM, which served as both the electron source and the vacuum chamber. The sample stage was moved along a predefined scanning path, directing the 10 keV electron beam at successive regions of the membrane window. Three regions are distinguished

(Fig. 1): A - full silicon substrate, $\sim 350 \mu\text{m}$ thick; B - sloped pyramid wall formed during KOH etching; C - Si_3N_4 membrane, 100 nm thick. Signal intensities are reported relative to region C, taken as 100%. The recorded signal reflects the combined effect of electron scattering, energy loss, and Bremsstrahlung yield in the copper layer, rather than a simple beam transmission ratio.

3. Conclusion

The experiment quantified how the Si_3N_4 membrane and surrounding substrate geometry contribute to the CMOS signal. In region A no signal above the noise floor was detected (0%), confirming that the 350 μm silicon substrate fully absorbs the beam and X-rays that can be generated in it. In region B the signal increases as the silicon thickness decreases, indicating that the KOH-etched pyramid walls also contribute to the detected signal. In region C the signal reaches its maximum (100%). These results show that the etched window geometry significantly influences the signal and must be accounted for when separating membrane-related contributions from gas-related effects in future measurements at elevated pressure.

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- [2] K. Baranowski et al., Proc. IVNC 2025, doi:10.1109/IVNC65669.2025.11120851

MC-ThP-4 Development of a Smart Wearable for Tracking Vitamin D Levels for Preventative Healthcare, *Mason Wright, Sushma Kotru*, University of Alabama

Vitamin D deficiency is a global health issue affecting over 1 billion people worldwide. This deficiency can lead to serious health issues, such as weak bones and muscles, leading to increased fragility and likelihood of fractures; osteoporosis; and can worsen other conditions like cardiovascular disease, diabetes, autoimmune diseases, and some cancers. Most individuals are unaware of their Vitamin D levels. Currently, the only way to determine exact Vitamin D levels is through blood testing, which is not only cumbersome and expensive but also needs a visit to a physician. Though the rapid evolution of wearable devices has paved the way for non-invasive tracking of many health markers, there are no non-invasive products for

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calculation of vitamin D levels based on UV exposure. We have developed a personalized, real-time based, non-invasive Vitamin D tracker in the form of a touchscreen smartwatch with a companion mobile application. The device calculates a user's Vitamin D level over a period using the measured UV value from the sensor, time exposed, and user-inputted age, skin type, body exposure, and geolocation. Using the full-color LCD display, the user can navigate the interface and see their overall Vitamin D levels and recent history. The app stores long term history and provides preventive guidance to the users. This work demonstrates the feasibility of affordable, personalized Vitamin D tracking, which could be valuable in mitigating the global burden of vitamin D deficiency and shift the clinical paradigms toward accessible preventative healthcare.

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